



#### Welcome to Rehm Mexico's 10th Anniversary and Technology Days!

Join us as we celebrate a decade of success at Rehm Mexico with two days of innovation and collaboration. Our experts from Rehm Thermal Systems will present the latest in soldering and coating technologies, supported by real customer use cases. The event will include sessions on convection reflow soldering, protective conformal coating, and vapor phase soldering for high-mass boards. In the afternoon, take part in technical workshops on our cutting-edge systems.

On the second day, join us for a panel discussion on future trends in electronics manufacturing, followed by a live machine demonstration and a tour of our Technology Center.

**YEARS** Rehm Thermal Systems **MEXICO** 

We look forward to celebrating and innovating with you!

# **AGENDA**

### Wednesday | July 2, 2025

09.00 a.m	Registration
09.30 a.m	Welcome   10 Years Rehm Mexico
	Johannes Rehm, CEO Rehm Group
10.00 a.m	Innovative system technology for convection
	reflow soldering - customer use case A
	Dr. Paul Wild, Rehm Thermal Systems
10.30 a.m	Protective Conformal Coating for PCB's
	- customer use case A
	Gianfranco Sinistra, Rehm Thermal Systems

11.00 a.m **Coffee Break** 11.30 a.m Vapor Phase Soldering for high-mass boards

> - customer use case B Dr. Paul Wild, Rehm Thermal Systems

12.00 a.m **Conformal Coating and Dispensing Solutions** for special applications

- customer use case B

Gianfranco Sinistra, Rehm Thermal Systems

01.00 p.m. **Lunch** 

02.00 p.m. **Technical workshops** • VisionXP+ 944 VAC system

04.30 p.m · CondensoXC

• ProtectoXC - Live Case Discussion together with the specialist Lackwerke Peters and

Gianfranco Sinistra

07.00 p.m Celebration Dinner

# Thursday | July 3, 2025

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09.00 a.m	Registration
09.30 a.m	Welcome
	Luis A. García, General Manager Rehm México
09.45 a.m	Process Know-How for reflow soldering
	applications
	Dr. Paul Wild, Rehm Thermal Systems
10.30 a.m	Efficient Solutions for precise coating and
	despensing results
	Gianfranco Sinistra, Rehm Thermal Systems
11:15 a.m	Coffee Break
11.45 a.m	Solder Graping Issue Analysis
	Dr. Jose Ma. Servin Olivares, Vitesco Cuautla
12:15 a.m	Causes of Solder Separation and Possible Solut
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tions Master of Science Omar Garcia Lopez, Flex North

01:00 p.m Lunch

02.00 p.m Panel Discussion: Future trends in electronics manufacturing processes

Johannes Rehm, Luis A. García, Gianfranco Sinistra,

Dr. Paul Wild, Ricardo Gallardo - Sanmina, Lorena Villanueva - IPC Mexico and other experts

03.00 p.m **Open Machine Demonstration** 

**Technology Center Tour** 

04.00 p.m End of event

Contents subject to change without notice.

### **Information and Registration**

Rehm Thermal Systems SA de CV Parque Industrial TREX La Venta Carretera a Nextipac No. 6645, Colonia La Venta del Astillero, int. Nave 10, Municipio de Zapopan, Jal., CP. 45221

La Macarena — Salón Boutique Av. Vallarta 6112, Ciudad Granja, Zapopan, Jal. 45017 México

**Evening location** 

#### **Registration Link**



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